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Displacement Damage Effect Due to Neutron and Proton Irradiations on CMOS Image Sensor

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Overview

Goal : Study of **displacement damage** effects on **CMOS sensors** manufactured in a **deep sub-micron** technology **dedicated to imaging** applications

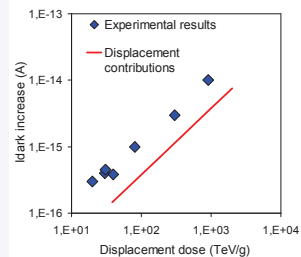
Test structures : pixel arrays + isolated large photodiodes

Main result :

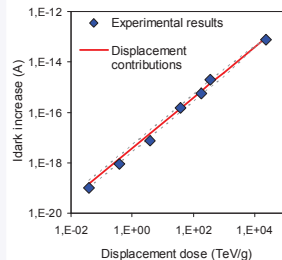
- Main damage due to displacement is **dark current increase**
- Proton displacement effect
- Neutron and proton induce **equivalent** displacement damage
- Analytic model, based on damage energy, could predict dark current increase distribution in APS
- Defects responsible of dark current increase are **intrinsic defects** probably in the form of **cluster**

Effects on CMOS sensors

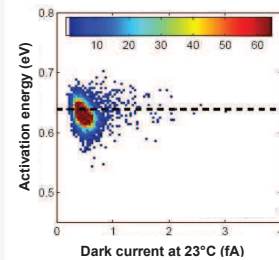
■ No photoresponse degradation, no voltage shift, no gain reduction



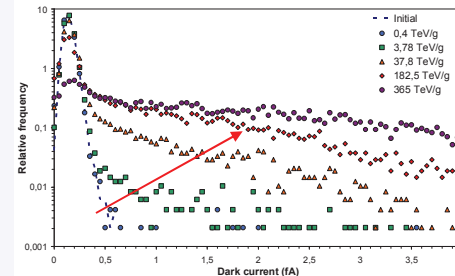
Proton induced displacement damages effects on mean dark current are **negligible** in front of **ionizing dose**



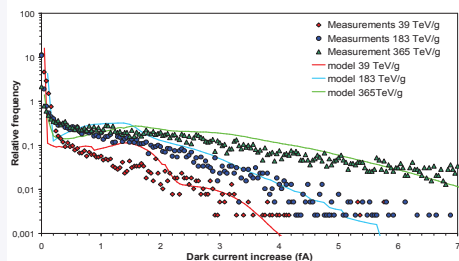
Neutron induces essentially Displacement damages



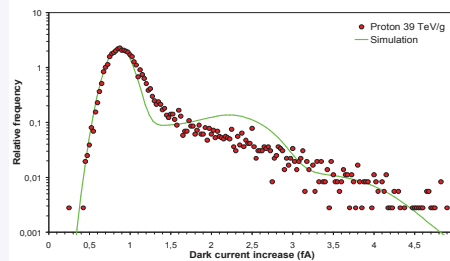
No sign of electric field enhancement at the Si-STI interface



Pixel tail, due to neutron induced displacement, increases following displacement damage dose



- Histogram observations of **dark current increase** due to **neutron irradiation** are compared to estimates based on **GEANT 4** calculations of the **recoil spectrum parameters**
- Estimation of dark current increase is calculated using the **recoil element damage energy**



- **Proportionality between damage energy and dark current increase** based on **NIEL** is used
- **Analytic model** is convolved with ionization fit to obtain **proton induced dark current increase distribution**.

Experimental

Test chip :

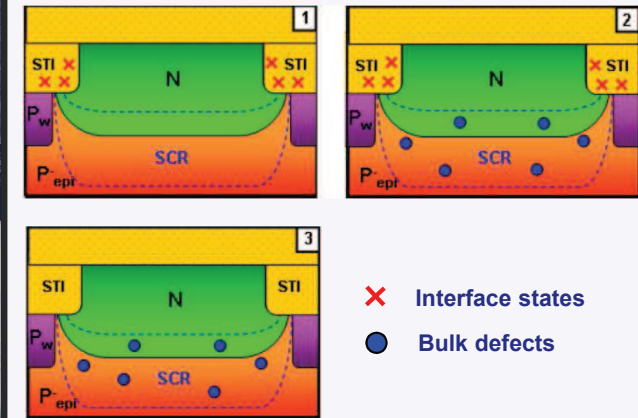
- 0.18 μm CMOS **CIS** technology
- **Dedicated photodiode** doping profiles
- 128 x 128 pixel arrays, **3T**, 10 μm pitch
- Large photodiodes ($>10^4 \mu\text{m}^2$)

Proton irradiation :

- Facilities : KVI, UCL, TRIUMF
- Energies : **50 to 500 MeV**
- Fluences : 5×10^9 to $1 \times 10^{11} \text{H}^+/\text{cm}^2$

Neutron irradiation :

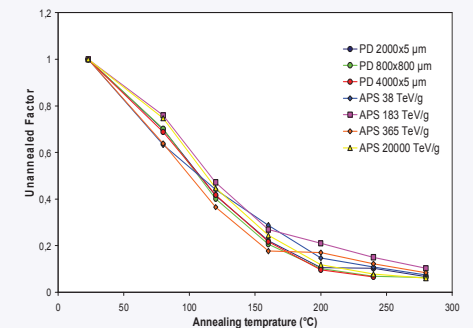
- Facilities : CEA Valduc, UCL
- Energies : **0.8 to 20 MeV**
- Fluences : 5×10^9 to $1 \times 10^{13} \text{N}/\text{cm}^2$



Main defects inducing **dark current increase** in photodiode, after **γ -ray** (1), **proton** (2) and **neutron** (3) irradiations :

- **Ionization** induces **interface states** in Shallow Trench Isolation (STI)
- **Displacement** induces **point defects** and **clusters of defects** in space charge region (SCR)

Annealing



Unannealed dark current fraction and DLTS measurements show that defects inducing dark current increase could be probably in the form of **clusters**